

XTR111 Demonstration Fixture

This user's guide describes the characteristics, operation, and use of the XTR111EVM evaluation module (EVM). This EVM features the XTR111 voltage-to-current converter and has a flexible configuration, allowing for evaluation suitable to a variety of applications.

The following related documents are available through the Texas Instruments web site at www.ti.com.

Related Documentation from Texas Instruments

Documenr	Literature Number
XTR111 Product Data Sheet	SBOS375
QFN / SON PCB Attachment Application Note	<u>SLUA271</u>
Quad Flatpack No-Lead Logic Packages Application Note	SCBA017

1 XTR111 and XTR111EVM Overview

1.1 XTR111

The $\underline{\mathsf{XTR111}}$ is a precision voltage-to-current converter designed for standard 0mA to 20mA or 4mA to 20mA analog signals, but it can source up to 36mA. The ratio between input voltage and output current is set by the single resistor, $\mathsf{R}_{\mathsf{SET}}$. This reference resistor is an external device because absolute accuracy is required and the performance can be selected to meet the application requirements.

The circuit can also be modified for voltage output.

An external P-MOSFET ensures high output resistance and a broad compliance voltage range extending from 2V below the positive supply (VSP) to voltages well below the negative supply (Gnd).

The adjustable 3V to 15V sub-regulator output provides the supply voltage for additional circuitry.

An error flag (EF) is provided to indicate fault conditions on the current output. This flag indicates open load or high load resistance.

The XTR111 also provides output disable control (OD). OD must be asserted low to activate the output.

The XTR111 is currently available in a DFN surface-mount package. An MSOP package option will be available in Q2 2007.

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1.2 XTR111EVM Overview

The XTR111EVM is intended to provide basic evaluation of XTR111 functionality. The fixture layout is not intended to be a model for the target circuit, nor is it laid out for electromagnetic compatibility (EMC) testing.

The layout of the XTR111EVM printed circuit board (PCB) is designed to provide:

- Easy handling of the small device package. A mechanical drawing of the recommended land pattern is found at the end of the product data sheet.
- Easy access to all pins of the device.
- Space for optional resistors and capacitors, as well as for the load resistor and a signal low-pass filter.
 Components are placed with adequate spacing, to allow modification and population with SOIC or leaded components.
- Resistors in the I/O connections to add additional handling protection for the EVM (these resistors may not be used in the final circuit).
- Open space around the IC to allow eventual re-soldering.

The external MOSFET mounted to the EVM is selected randomly from the available sources. Refer to the manufacturer's product data sheet for specification and limits.

The XTR111EVM is initially configured to a basic setup for 0mA to 20mA with 0V to 4V input . Note that the accuracy of R5 (R_{SET}) used in the EVM is only 0.1%, whereas the XTR111 has greater accuracy. The other resistors are standard 1%. The voltage regulator is set to 5V.

The EVM requires one external supply voltage. The supply voltage range is 8V to 40V.

Refer to the XTR111 product data sheet for comprehensive information about the XTR111 and possible device configurations. Figure 1 shows the XTR111 EVM.

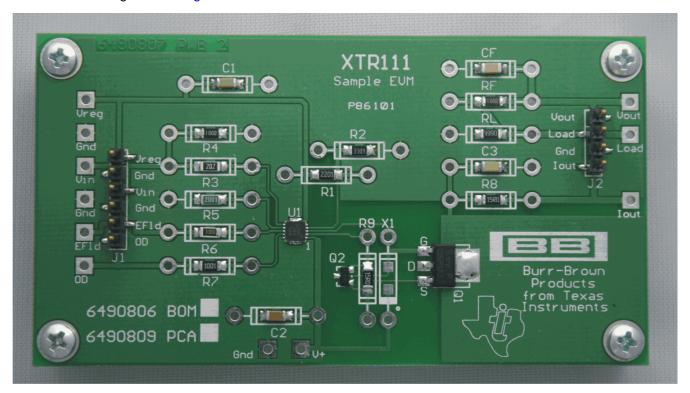


Figure 1. XTR111EVM



2 Quick Start Setup and Use

Follow these procedures to set up and use the XTR111EVM. See Figure 2.

- Connect an external dc supply voltage of approximately +24V to the V+ connector, referenced to the Gnd connector.
- Connect **OD** to **Gnd** (to enable the output).
- Connect I_{OUT} to Load.
- Turn power on. Expect a supply current of less than 0.6mA (without load and after charging the bypass capacitors). The voltage at Vout should stay close to Gnd with a small amount of offset (use an oscilloscope to observe the output signal).
- Connect a function generator or signal source to Vin referenced to Gnd. With R_{SET} of 2kΩ, the voltage at Vin must be set within 0V to 4V for 0mA to 20mA output.
- Connect lout to Load and measure the voltage at Vout, or disconnect lout from Load and then
 measure lout.

Note: The accuracy for V to I conversion relies on R5 (R_{SET}); RL is only a conventional 1% resistor.

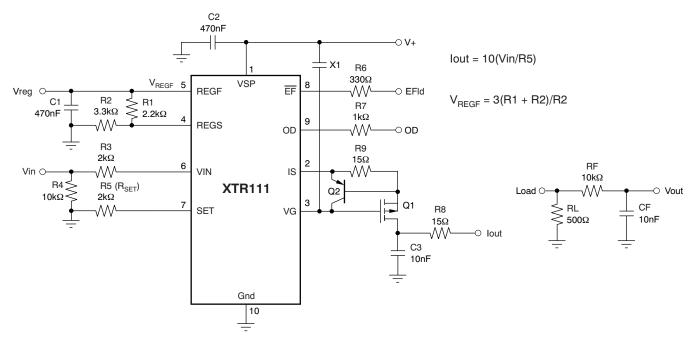


Figure 2. XTR111 EVM Circuit



3 Description of Components

This section summarizes the XTR111EVM components. (See also Figure 3).

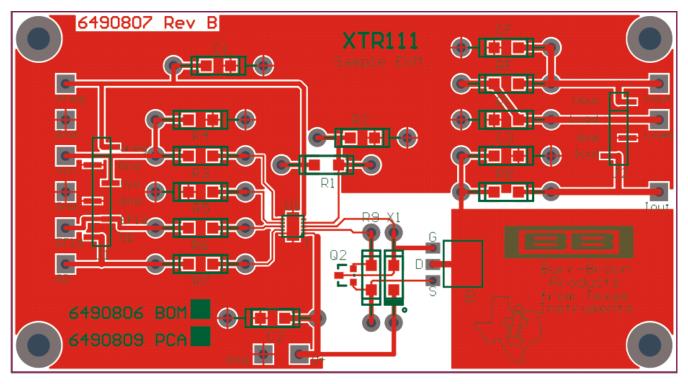


Figure 3. XTR111EVM PCB (Top Layer)

- R1 and R2 adjust the output voltage of the voltage regulator. Both resistors influence drift and dc accuracy. Vreg is set to 5V.
- R3 matches R5 (R_{SET}) for approximate cancellation of the bias current. This resistor also limits the current into the input if a signal is connected while power is off.
- R4 is used on the EVM input to provide a signal reference while no signal is connected.
- R5 (R_{SET}): This resistor defines the voltage-to-current conversion ratio. It influences drift and dc accuracy (a 0.1%, 25ppm resistor is soldered in). With R_{SET} = $2k\Omega$, the circuit converts 0V to 4V into 0mA to 20mA (lout = $10 \times Vin/R_{SET}$).
- R6 and R7 are used to protect the digital I/O on the EVM.
- OD connected to Gnd activates the output. Left unconnected, a logic high or connection to Vreg
 disables the output.
- **EF** is an open-drain output with internal weak pull-up. A low indicates an error. For secure operation, a pull-up resistor to logic supply is recommended. See the *Digital I/O* section.
- **R8** can be used to decouple the drain connection from the outgoing wire. It can form a filter together with C3 to decouple the output from interfering signals.
- RL (500Ω) converts the output current into voltage, referred to Gnd, if lout is connected to Load.
- RF forms a low-pass filter together with CF.
- R9 (15Ω) limits the current to approximately 37mA.



Digital I/O www.ti.com

With RF = $10k\Omega$ and CF = 10nF, $\tau = 100us$.

- C1 is the capacitive bypass and capacitive load for the voltage regulator.
- **C2** is the supply bypass capacitor; use 100nF or larger.
- **CF** is part of the signal filter, together with RF.
- X1 is a placeholder for a capacitor that slows down gate control. It reduces the influence of the drain to gate capacitance. This capacitor is normally not required.
- Gnd: There is only one ground for this circuit. A single-sided PCB was chosen for the EVM.

Refer to the product data sheet for options and details.

Digital I/O 4

The error flag EF is an open-drain output with an internal pull-up current of only 1µA to approximately 5V. This small current allows the user to observe the error flags with the $10M\Omega$ scope probe on the EVM. For normal operation, with connection to external logic inputs, an external pull-up resistor to logic supply is recommended. The control input for OD is internally pulled high with 4μA. If this input is left unconnected, the XTR111 is in disable mode; therefore, connection to this pin is normally required.

4.1 **Current Output**

The XTR111 is designed for use with a discrete P-Channel MOSFET. This FET extends the voltage compliance for the controlled current to a potential well below the negative supply voltage, because it is not limited to the negative supply. It also eases circuit protection and heat dissipation.

4.2 Layout and Grounds

The XTR111EVM has the load resistor connected to the main GND. If this configuration is not desired for testing, lout (not connected to Load) can be connected to an external load. The resistor R5 (R_{SET}) defines the voltage to current ratio; therefore, the reference point for this resistor is the signal input reference, as well. On the EVM, it is just connected to **Gnd**. Note that the exposed thermal flag must be connected to the most negative supply (normally **Gnd**).

The XTR111 uses internal chopping techniques to maintain its high accuracy and low drift. Therefore, sufficient supply bypassing with a low ESR capacitor is recommended.

Note: The EVM layout provides only marginal heat sinking for the XTR111 package. It is assumed sufficient for the purpose of the EVM because the fixture is mainly intended for quick and easy evaluation of the XTR111.

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM with supplies of $8V \le V+ \le 40V$, and within the input voltage range of 0V to 12V or 0V to (V+) - 2.3V, whichever is less, and the output range of 0mA to 36mA or 0V to 12V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than +50°C. The EVM is designed to operate properly with certain components above +50°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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